

IGBT - Power, Co-PAK, N-Channel, Field Stop VII (FS7), SCR, Power TO247-4L 1200 V, 1.45 V, 40 A AFGH4L40T120RWD

Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 4-lead package, this device offers the optimum performance with low on state voltage and minimal switching losses for both hard and soft switching topologies in automotive applications.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature $T_J = 175$ °C
- Short Circuit Rated and Low Saturation Voltage
- Fast Switching and Tightened Parameter Distribution
- AEC-Q101 Qualified, PPAP Available Upon Request
- These Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

- Automotive E-compressor
- Automotive EV PTC Heater
- OBC

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

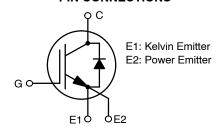
Parameter		Symbol	Value	Unit
Collector-to-Emitter Vol	V _{CE}	1200	V	
Gate-to-Emitter Voltage		V_{GE}	±20	
Transient Gate-to-Emitt	er Voltage		±30	
Collector Current	T _C = 25°C	I _C	80	Α
	T _C = 100°C		40	
Power Dissipation	T _C = 25°C	P _D	576	W
	T _C = 100°C		288	
Pulsed Collector Current	$T_{C} = 25^{\circ}C,$ $t_{p} = 10 \mu s \text{ (Note 1)}$	I _{CM}	120	Α
Diode Forward Current T _C = 25°C		I _F	80	
	T _C = 100°C		40	
Pulsed Diode Forward Current	$T_C = 25^{\circ}C,$ $t_p = 10 \ \mu s \ (Note 1)$	I _{FM}	120	
Short Circuit Withstand V _{GE} = 15 V, V _{CC} = 800 V	T _{SC}	6	μs	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C
Lead Temperature for So	T_L	260		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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BV _{CES}	VCE _(sat) TYP	I _C MAX
1200 V	1.45 V	40 A

PIN CONNECTIONS





TO-247-4LD CASE 340CJ

MARKING DIAGRAM



AFGH40120RWD = Specific Device Code &Z = Assembly Plant Code &3 = 3-Digit Date Code &K = 2-Digit Lot Traceability Code \$Y = onsemi Logo

ORDERING INFORMATION

Device	Package	Shipping
AFGH4L40T120RWD	TO-247-4L (Pb-Free)	30 Units / Rail

^{1.} Repetitive rating: Pulse width limited by max. junction temperature

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case for IGBT	$R_{\theta JC}$	0.26	°C/W
Thermal Resistance, Junction-to-Case for Diode	$R_{\theta JC}$	0.46	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector-to-Emitter Breakdown Voltage	BV _{CES}	$V_{GE} = 0 \text{ V}, I_{C} = 1 \text{ mA}$	1200	-	-	V
Collector-to-Emitter Breakdown Voltage Temperature Coefficient	ΔBV _{CES} / ΔΤ _J	V_{GE} = 0 V, I_{C} = 9.99 mA	-	1226	-	mV/°C
Zero Gate Voltage Collector Current	I _{CES}	V _{GE} = 0 V, V _{CE} = V _{CES}	-	-	40	μΑ
Gate-to-Emitter leakage Current	I _{GES}	V _{GE} = ±20 V, V _{CE} = 0 V	-	-	±400	nA
ON CHARACTERISTICS						
Gate-to-Emitter Threshold Voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_{C} = 40$ mA, $T_{J} = 25$ °C	4.98	5.88	6.78	V
Collector-to-Emitter Saturation Voltage	V _{CE(sat)}	$V_{GE} = 15 \text{ V}, I_{C} = 40 \text{ A}, T_{J} = 25^{\circ}\text{C}$	-	1.45	1.78	V
		V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	-	1.75	_	
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{IES}	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	4713	-	pF
Output Capacitance	C _{OES}		1	195	-	pF
Reverse Transfer Capacitance	C _{RES}		_	23.8	-	pF
Total Gate Charge	Q_{G}	V _{CE} = 600 V, V _{GE} = 15 V, I _C = 40 A	_	171	-	nC
Gate-to-Emitter Charge	Q _{GE}	I _C = 40 A	-	42.2	-	nC
Gate-to-Collector Charge	Q _{GC}		_	73.1	-	nC
SWITCHING CHARACTERISTICS	•				•	
Turn-On Delay Time	t _{d(on)}	V _{CE} = 600 V	-	53.5	_	ns
Turn-Off Delay Time	t _{d(off)}	V _{GE} = 0/15 V I _C = 20 A	_	311	-	
Rise Time	t _r	$R_G = 6 \Omega$ $T_{,l} = 25^{\circ}C$	-	27.8	-]
Fall Time	t _f	1	1	189	-]
Turn-On Switching Loss	E _{on}		-	1.26	-	mJ
Turn-Off Switching Loss	E _{off}		-	1.36	-]
Total Switching Loss	E _{ts}		-	2.61	_	
Turn-On Delay Time	t _{d(on)}	V _{CE} = 600 V	-	58.2	-	ns
Turn-Off Delay Time	t _{d(off)}	$V_{GE} = 0/15 \text{ V}$ $I_{C} = 40 \text{ A}$	-	258	-]
Rise Time	t _r	$R_G = 6 \Omega$ $T_J = 25^{\circ}C$	-	47.4	-	
Fall Time	t _f	., 200	-	122	-	
Turn-On Switching Loss	E _{on}		-	3.38	-	mJ
Turn-Off Switching Loss	E _{off}		-	1.7	-	1
Total Switching Loss	E _{ts}	1	-	5.08	-	1

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS			•			-
Turn-On Delay Time	t _{d(on)}	V _{CE} = 600 V	-	58.7	_	ns
Turn-Off Delay Time	t _{d(off)}	$V_{GE} = 0/15 \text{ V}$ $I_{C} = 20 \text{ A}$	-	433	-	
Rise Time	t _r	R _G = 6 Ω T _J = 175°C	-	39.4	-	1
Fall Time	t _f	.,	-	376	-	1
Turn-On Switching Loss	E _{on}		_	2.01	_	mJ
Turn-Off Switching Loss	E _{off}		-	2.52	-	1
Total Switching Loss	E _{ts}		-	4.53	_	1
Turn-On Delay Time	t _{d(on)}	V _{CE} = 600 V	-	65.7	-	ns
Turn-Off Delay Time	t _{d(off)}	$V_{GE} = 0/15 \text{ V}$ $I_{C} = 40 \text{ A}$	-	343	_	1
Rise Time	t _r	R _G = 6 Ω T _J = 175°C	-	64.7	_	1
Fall Time	t _f	.,	-	233	_	1
Turn-On Switching Loss	E _{on}		-	5.45	_	mJ
Turn-Off Switching Loss	E _{off}		-	3.04	-	
Total Switching Loss	E _{ts}		-	8.49	_	1
DIODE CHARACTERISTICS						
Diode Forward Voltage	V _F	I _F = 40 A, T _J = 25°C	_	1.55	1.85	V
		I _F = 40 A, T _J = 175°C	-	1.54	_	
DIODE SWITCHING CHARACTERISTIC	S, INDUCTIVE LOAD)				
Reverse Recovery Time	t _{rr}	$V_R = 600 \text{ V}, I_F = 20 \text{ A},$ $dI_F/dt = 500 \text{ A}/\mu\text{s}$ $T_J = 25^{\circ}\text{C}$	-	145	-	ns
Reverse Recovery Charge	Q _{rr}		-	2055	-	nC
Reverse Recovery Energy	E _{rec}		-	0.49	_	mJ
Peak Reverse Recovery Current	I _{RRM}		-	34	-	Α
Reverse Recovery Time	t _{rr}	$V_R = 600 \text{ V}, I_F = 40 \text{ A},$ $dI_F/dt = 500 \text{ A}/\mu\text{s}$ $T_J = 25^{\circ}\text{C}$	-	182	-	ns
Reverse Recovery Charge	Q _{rr}		-	3527	_	nC
Reverse Recovery Energy	E _{rec}		-	0.67	_	mJ
Peak Reverse Recovery Current	I _{RRM}		-	43.5	_	Α
Reverse Recovery Time	t _{rr}	$V_R = 600 \text{ V}, I_F = 20 \text{ A},$	-	204	-	ns
Reverse Recovery Charge	Q _{rr}	$dI_F/dt = 500 \text{ A/}\mu\text{s}$ $T_J = 175^{\circ}\text{C}$	-	3606	-	nC
Reverse Recovery Energy	E _{rec}		-	1.07	_	mJ
Peak Reverse Recovery Current	I _{RRM}		-	42.3	_	Α
Reverse Recovery Time	t _{rr}	$V_R = 600 \text{ V}, I_F = 40 \text{ A},$	-	253	_	ns
Reverse Recovery Charge	Q _{rr}	$dI_F/dt = 500 A/\mu s$ $T_J = 175^{\circ}C$	-	6542	-	nC
Reverse Recovery Energy	E _{rec}		-	1.52	_	mJ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

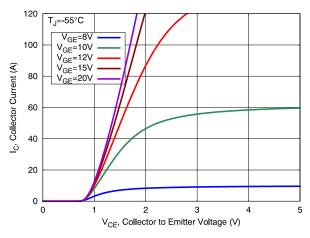


Figure 1. Output Characteristics

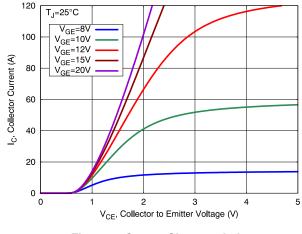


Figure 2. Output Characteristics

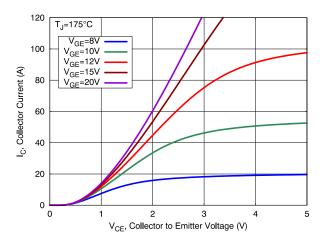


Figure 3. Output Characteristics

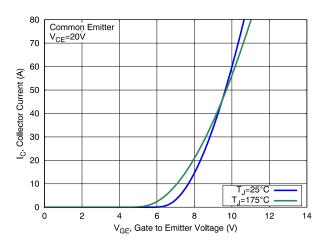


Figure 4. Transfer Characteristics

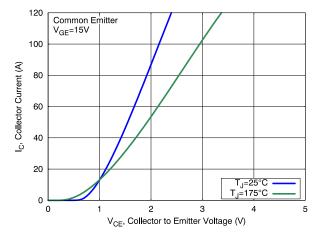


Figure 5. Saturation Characteristics

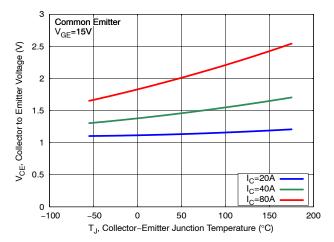


Figure 6. Saturation Voltage vs. Junction Temperature

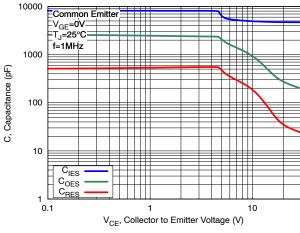


Figure 7. Capacitance Characteristics

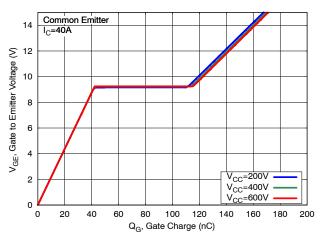


Figure 8. Gate Charge Characteristics

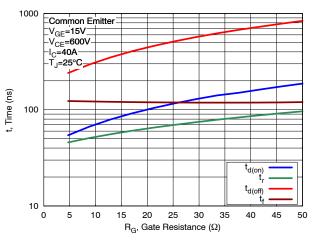


Figure 9. Switching Time vs Gate Resistance

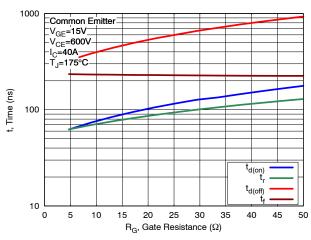


Figure 10. Switching Time vs Gate Resistance

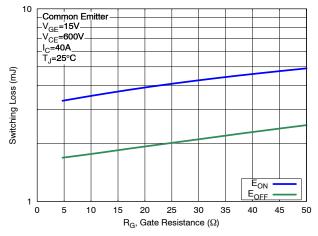


Figure 11. Switching Loss vs Gate Resistance

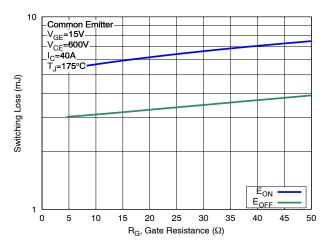


Figure 12. Switching Loss vs Gate Resistance

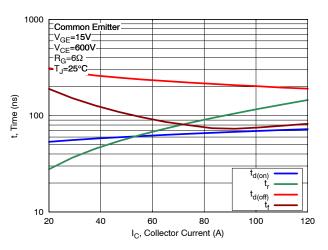


Figure 13. Switching Time vs Collector Current

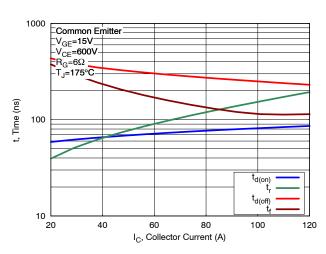


Figure 14. Switching Time vs Collector Current

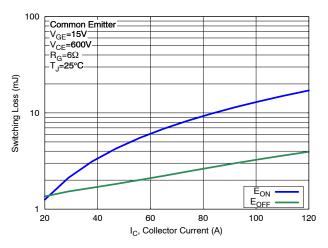


Figure 15. Switching Loss vs Collector Current

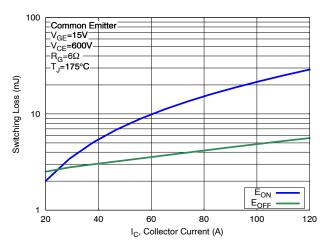


Figure 16. Switching Loss vs Collector Current

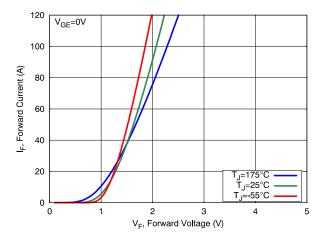


Figure 17. Diode Forward Characteristics

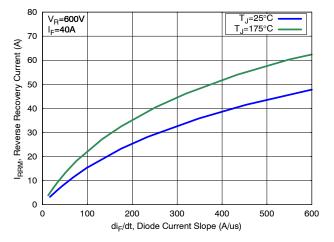
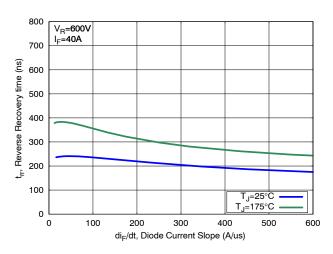


Figure 18. Diode Reverse Recovery Current



10000 V_R=600V I_F=40A Qrr Reverse Recovery Charge (nC) 8000 6000 4000 2000 T_J=25°C T_J=175°C 0 0 100 200 300 400 500 600 di_F/dt, Diode Current Slope (A/us)

Figure 19. Diode Reverse Recovery Time

Figure 20. Diode Stored Charge Characteristics

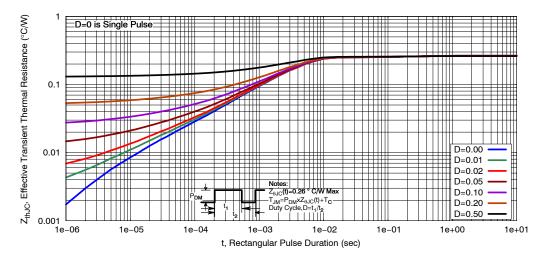


Figure 21. Transient Thermal Impedance of IGBT

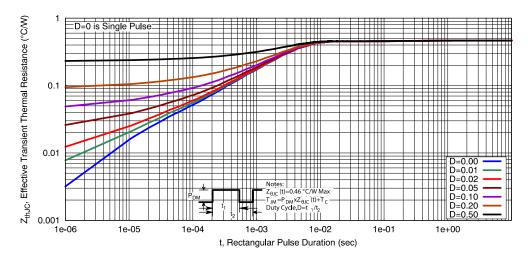


Figure 22. Transient Thermal Impedance of Diode

 \emptyset p1

D1

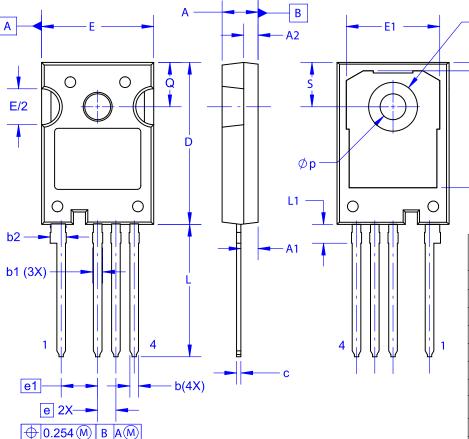
DIM

D2



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019



NOTES:

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 FLASH, AND TIE BAR EXTRUSIONS.
 C. ALL DIMENSIONS ARE IN MILLIMETERS.
 D. DRAWING CONFORMS TO ASME Y14.5-2009.

Α	4.80	5.00	5.20		
A1	2.10	2.40	2.70		
A2	1.80	2.00	2.20		
b	1.07	1.20	1.33		
b1	1.20	1.40	1.60		
b2	2.02	2.22	2.42		
С	0.50	0.60	0.70		
D	22.34	22.54	22.74		
D1	16.00	16.25	16.50		
D2	0.97	1.17	1.37		
е	2.54 BSC				
e1	5.08 BSC				
E	15.40	15.60	15.80		
E1	12.80	13.00	13.20		
E/2	4.80	5.00	5.20		
L	18.22	18.42	18.62		
L1	2.42	2.62	2.82		
р	3.40	3.60	3.80		
p1	6.60	6.80	7.00		
Q	5.97	6.17	6.37		
S	5.97	6.17	6.37		

MILLIMETERS

NOM

MAX

MIN

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